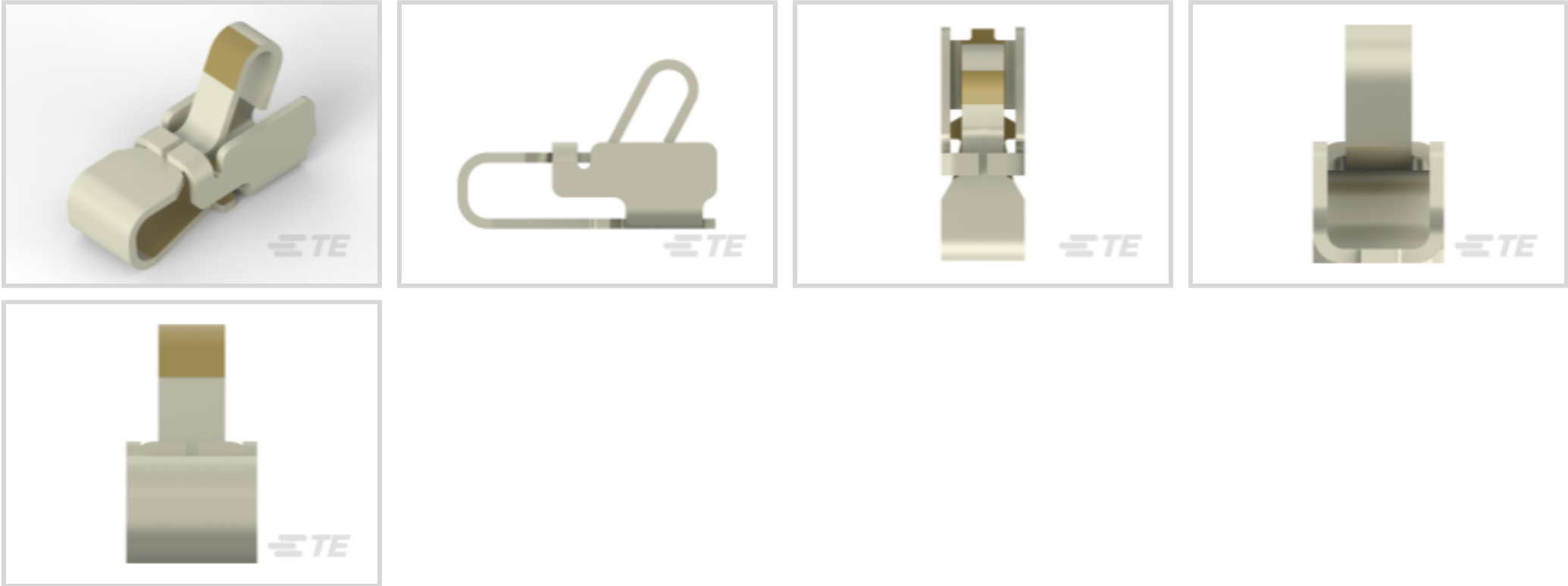




Connectors > Contacts > PCB Spring Contacts



Spring Finger Type: **Preloaded - C-Clip**

Scalable: **No**

Side Protected: **No**

Uncompressed Height: **2 mm [.079 in]**

Product Length: **3.15 mm [.124 in]**

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board
Spring Finger Type	Preloaded - C-Clip
Scalable	No

Configuration Features

Number of Positions	1
Side Protected	No

Contact Features

Contact Underplating Material	Nickel
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Gold
Contact Working Range (Low)	1.15 mm[.045 in]
Contact Working Range (High)	1.6 mm[.063 in]
Point of Contact Area Plating Material	Gold



Contact Current Rating (Max)	1.5 A
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Dimensions

Uncompressed Height	2 mm[.079 in]
Product Length	3.15 mm[.124 in]
Product Width	1.1 mm[.043 in]

Usage Conditions

Operating Temperature Range	-40 – 85 °C[-40 – 185 °F]
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Operation/Application

Circuit Application	Signal
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Packaging Features

Packaging Method	Tape & Reel
Packaging Quantity	6000

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>



Compatible Parts

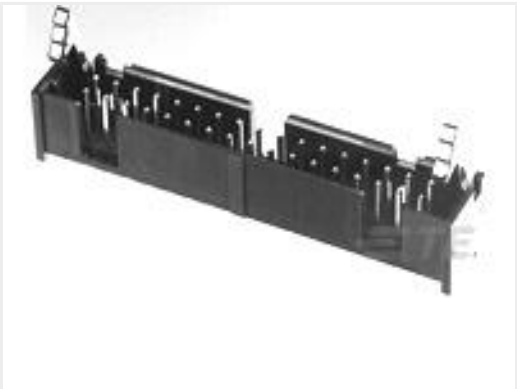


TE Part # 2822541-1
PUSH-PUSH MICRO SIM
CONNECTOR

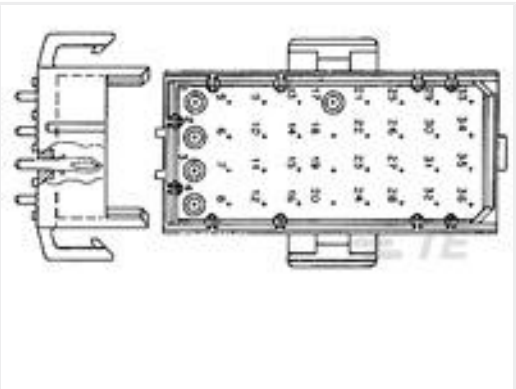


TE Part # 2305018-2
USB TYPE C, REC IPX8 ON BOARD
DUAL SMT


Customers Also Bought




TE Part #104313-1
010 LOPRO HDR SP 30DP LATCH



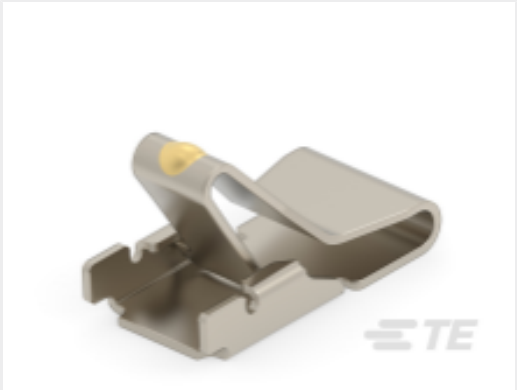
TE Part #2-640501-2
09P MR HDR ASSY VO LF




TE Part #CAT-AM74-UN384H
AMP-LATCH UNIVERSAL HEADERS




TE Part #5207719-4
FEMALE SCREWLOCK KIT,BULK PKG



TE Part #2306334-3
SPRING FINGER 1.2H



TE Part #3-2176456-0
CPF 0603 2R0 0.1% 25ppm 1K RL



TE Part #5747150-2
09 RCPT SP/FMS STD

Documents

Product Drawings
SHIELD FINGER 2011 EMBOSS PACKING
English

CAD Files
Customer View Model
ENG_CVM_CVM_1554901-1_A.2d_dxf.zip
English
3D PDF
3D
Customer View Model
ENG_CVM_CVM_1554901-1_A.3d_igs.zip
English
Customer View Model



ENG_CVM_CVM_1554901-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

Application Specification

English